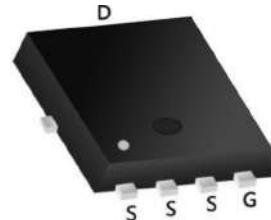


N-Ch 30V Fast Switching MOSFETs

Features:

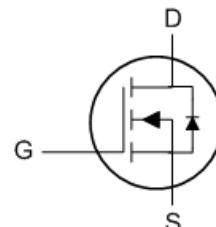
- * 100% UIS Tested
- * Advanced Trench Technology
- * Low Gate Charge
- * High Current Capability
- * RoHS and Halogen-Free Compliant



PRPAK5X6 Pin Configuration

Applications:

- Power Management in Desktop Computer
- DC/DC Converters



Product Summary

BVDSS	RDS(on)	ID
30V	2.2mΩ	85A

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	85	A
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	67	A
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	27	A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	21	A
I _{DM}	Pulsed Drain Current ²	250	A
EAS	Single Pulse Avalanche Energy ³	151	mJ
I _{AS}	Avalanche Current	55	A
P _D @T _C =25°C	Total Power Dissipation ⁴	48	W
P _D @T _A =25°C	Total Power Dissipation ⁴	2.5	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-Ambient ¹	---	50	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹	---	2.6	°C/W

Electrical Characteristics ($T_J=25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_D=250\mu\text{A}$	30	---	---	V
$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance ²	$\text{V}_{\text{GS}}=10\text{V}$, $\text{I}_D=20\text{A}$	---	1.8	2.2	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}$, $\text{I}_D=20\text{A}$	---	2.5	3.6	
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$, $\text{I}_D=250\mu\text{A}$	1.2	1.6	2.2	V
I_{DSS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=24\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $\text{T}_J=25\text{ }^{\circ}\text{C}$	---	---	1	uA
		$\text{V}_{\text{DS}}=24\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $\text{T}_J=55\text{ }^{\circ}\text{C}$	---	---	5	
I_{GSS}	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=\pm 20\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}}=5\text{V}$, $\text{I}_D=20\text{A}$	---	91	---	S
R_{g}	Gate Resistance	$\text{V}_{\text{DS}}=0\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	1.7	---	Ω
Q_{g}	Total Gate Charge (4.5V)	$\text{V}_{\text{DS}}=15\text{V}$, $\text{V}_{\text{GS}}=10\text{V}$, $\text{I}_D=20\text{A}$	---	21	---	nC
Q_{gs}	Gate-Source Charge		---	12.5	---	
Q_{gd}	Gate-Drain Charge		---	14.5	---	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time	$\text{V}_{\text{DD}}=15\text{V}$, $\text{V}_{\text{GS}}=10\text{V}$, $\text{R}_{\text{G}}=3.3\Omega$, $\text{I}_D=20\text{A}$	---	12	---	ns
T_{r}	Rise Time		---	6	---	
$\text{T}_{\text{d(off)}}$	Turn-Off Delay Time		---	38.5	---	
T_{f}	Fall Time		---	11.5	---	
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=15\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	3032	---	pF
C_{oss}	Output Capacitance		---	1588	---	
C_{rss}	Reverse Transfer Capacitance		---	207	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_{s}	Continuous Source Current ^{1,6}	$\text{V}_{\text{G}}=\text{V}_{\text{D}}=0\text{V}$, Force Current	---	---	85	A
V_{SD}	Diode Forward Voltage ²	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_{\text{s}}=1\text{A}$, $\text{T}_J=25\text{ }^{\circ}\text{C}$	---	---	1.2	V

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $\text{V}_{\text{DD}}=25\text{V}$, $\text{V}_{\text{GS}}=10\text{V}$, $\text{L}=0.1\text{mH}$, $\text{I}_{\text{AS}}=55\text{A}$
- 4.The power dissipation is limited by $150\text{ }^{\circ}\text{C}$ junction temperature
- 5.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.
- 6.Package limitation current is 85A.

Typical Characteristics

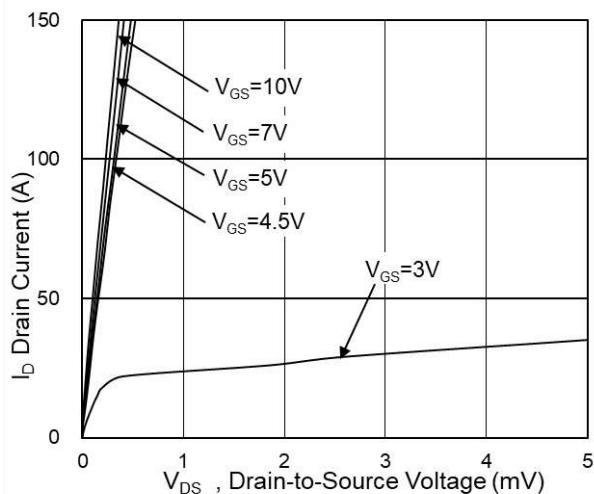


Fig.1 Typical Output Characteristics

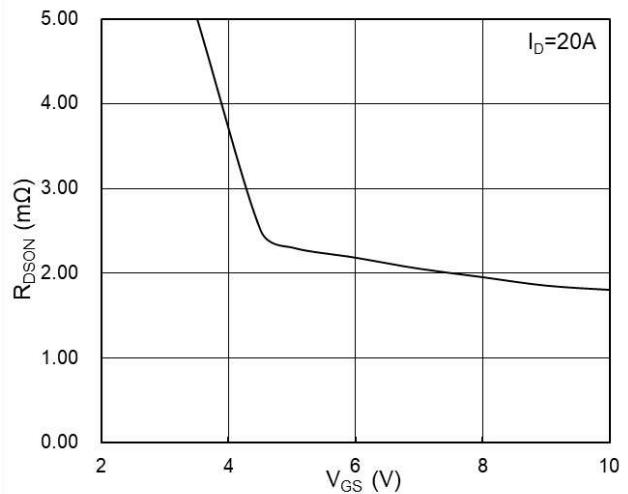


Fig.2 On-Resistance vs G-S Voltage

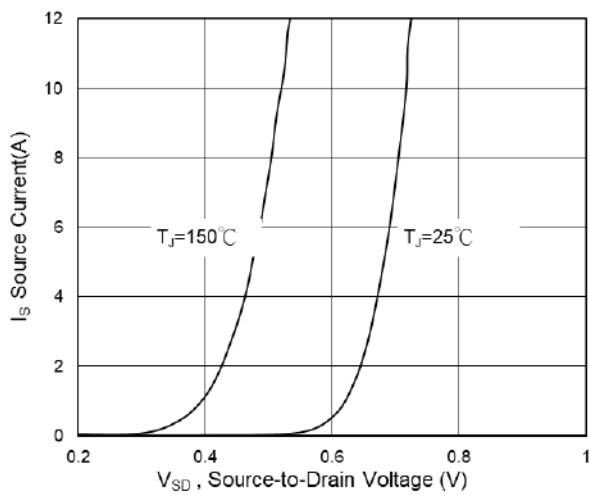


Fig.3 Source Drain Forward Characteristics

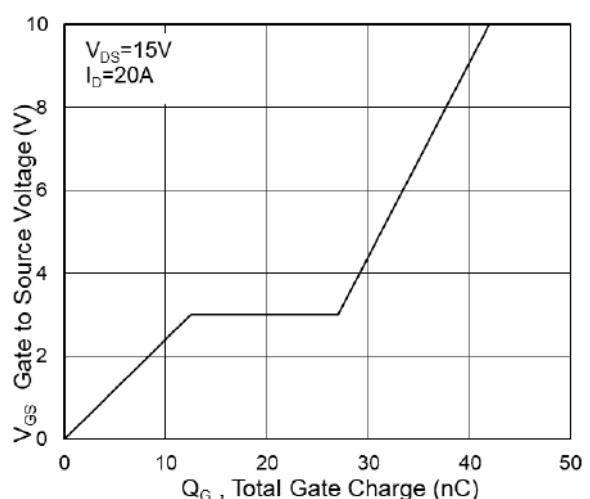


Fig.4 Gate-Charge Characteristics

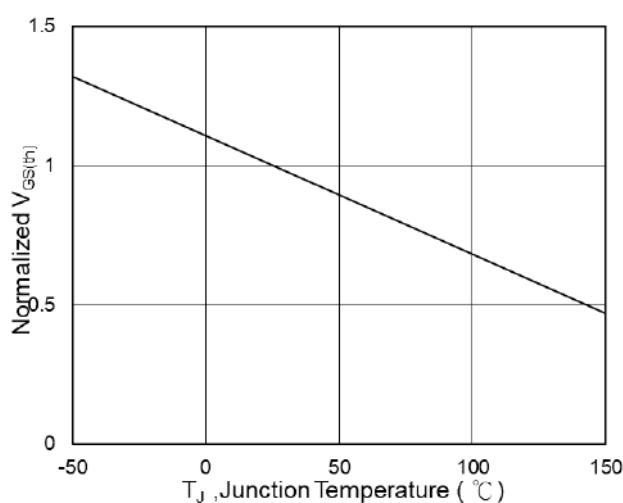


Fig.5 Normalized V_GS(th) vs T_J

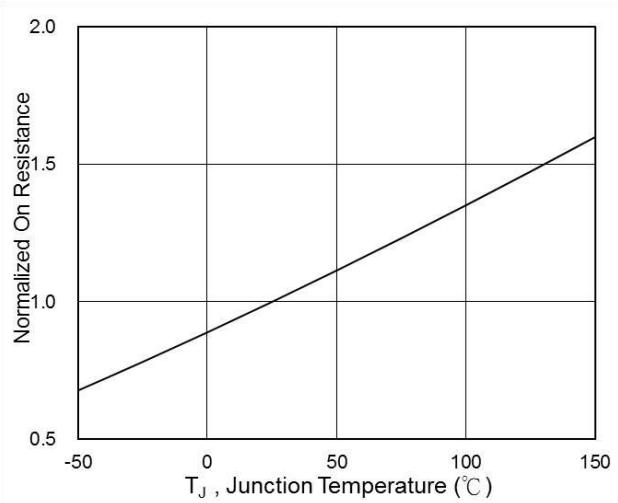


Fig.6 Normalized R_DS(on) vs T_J

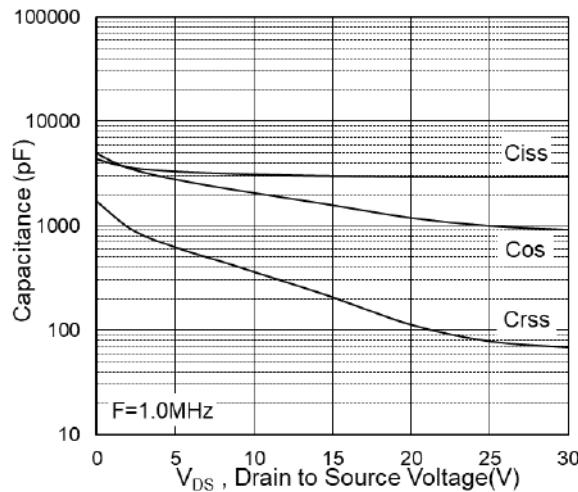


Fig.7 Capacitance

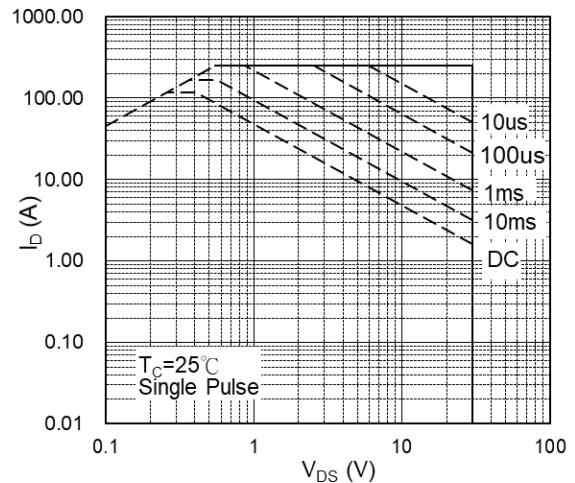


Fig.8 Safe Operating Area

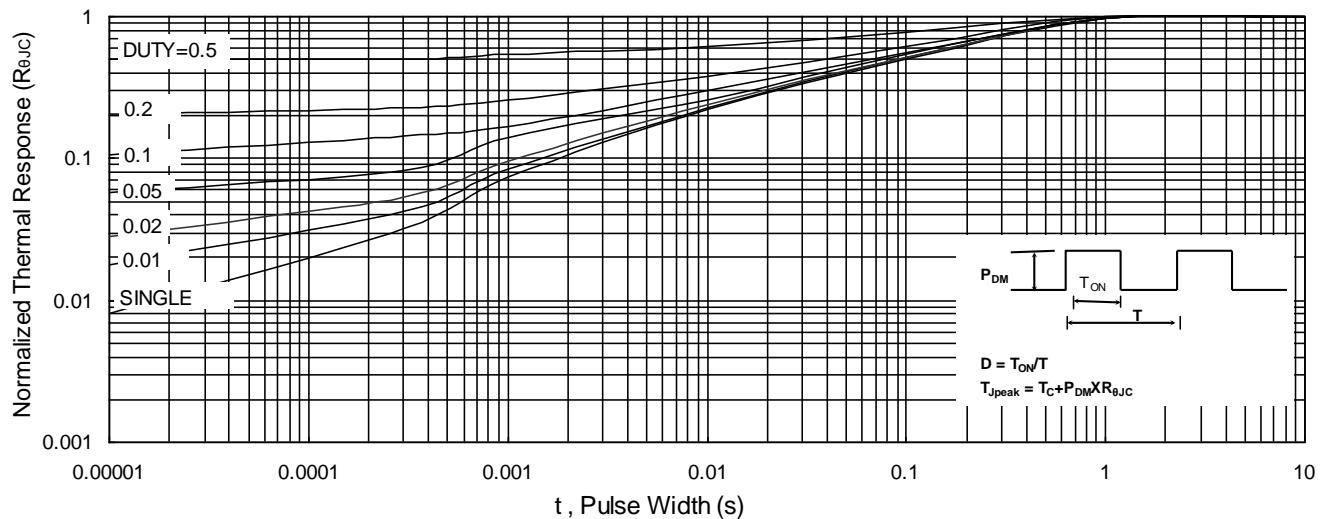


Fig.9 Normalized Maximum Transient Thermal Impedance

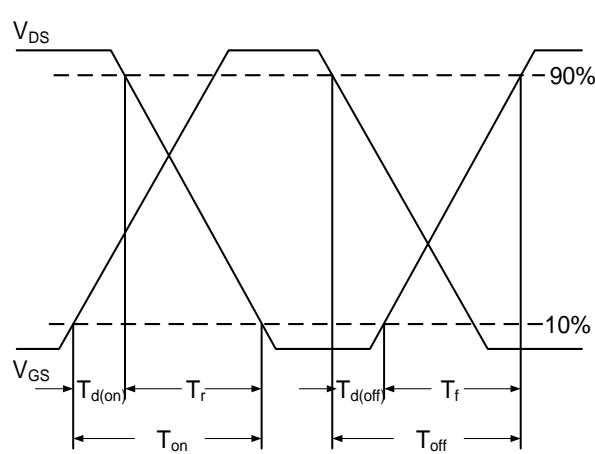


Fig.10 Switching Time Waveform

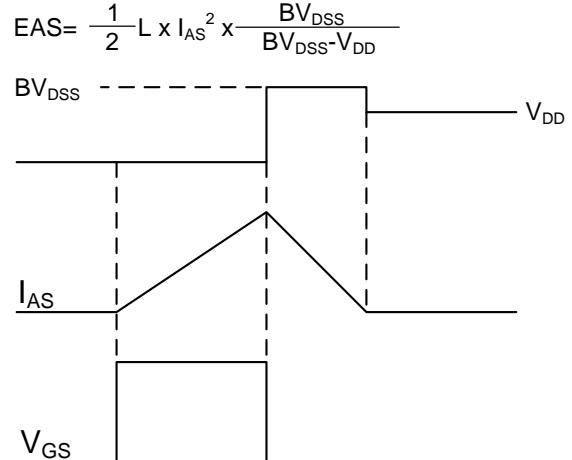
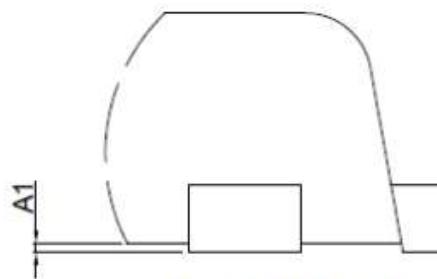
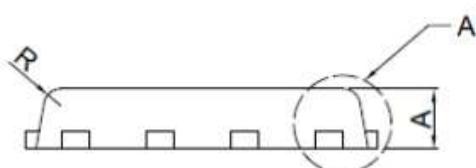
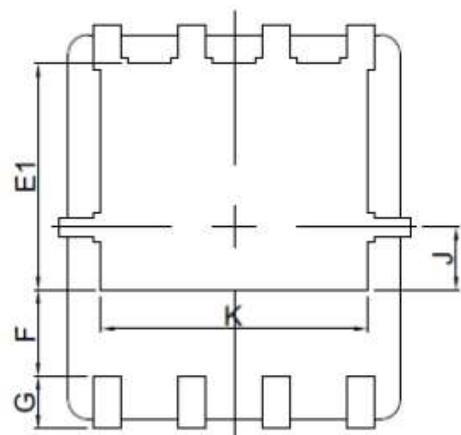
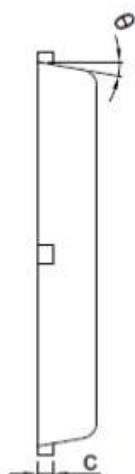
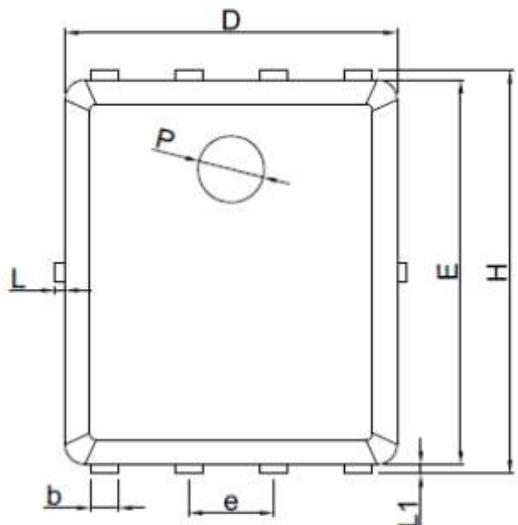


Fig.11 Unclamped Inductive Switching Waveform

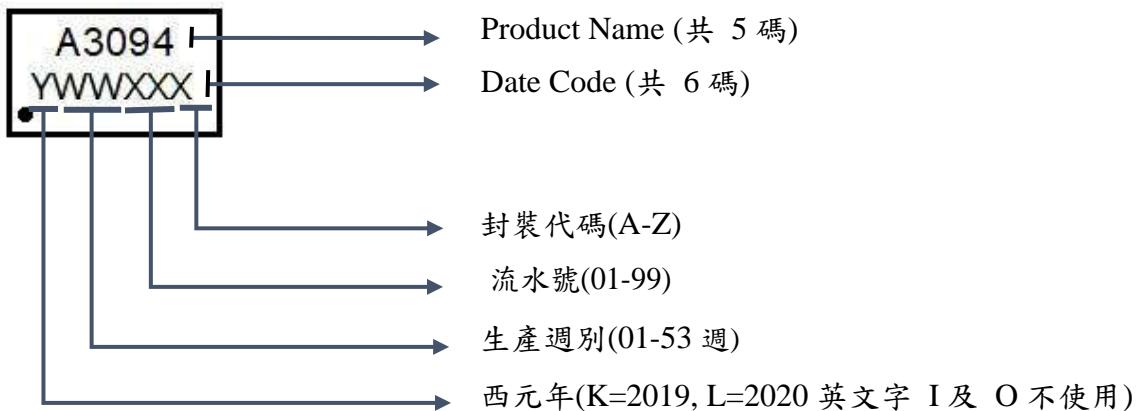
PRPAK5x6 Package Outline Dimension



DETAIL "A"

SYMBOL	MIN	NOM	MAX
A	0.80	0.90	1.00
A ₁	0.00	0.03	0.05
b	0.35	0.42	0.49
c	0.254REF		
D	4.90	5.00	5.10
F	1.40REF		
E	5.70	5.80	5.90
e	1.27BSC		
H	5.95	6.08	6.20
L1	0.10	0.14	0.18
G	0.60REF		
K	4.00REF		
L	—	—	0.15
J	0.95BSC		
P	1.00REF		
E1	3.40REF		
θ	6°	10°	14°
R	0.25REF		

PRPAK5X6 Marking Instruction



PRPAK5x6 Tape and Reel Dimension

